

COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

DUAL DAMASCENE STRUCTURE FOR THE WIRING-LINE STRUCTURES OF MULTI-LEVEL INTERCONNECTS IN THE INTEGRATED CIRCUIT

the specification of which

___ is attached hereto.

X was filed on 2003/7/29

as Application Serial No. 10/630,643 and was amended on _____.

I hereby state that I have reviewed and understood the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Number	Country	Date Filed(yyyy/mm/dd)	Yes	No
87110937	Taiwan R.O.C.	1998/7/7		X

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below, and insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code § 112, I acknowledge the duty to disclose to the U.S. Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, code of Federal Regulations, § 1.56, which became available between the filing date of the prior application and the national or PCT international filing date of this application:

U.S. Patent Application Ser. No. 09/849,391, filed May 04, 2001.

U.S. Patent No. 6,265,780, issued on July 24, 2001.

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Jiawei Huang	(Reg. No. 43,330)	Charles C.H. Wu	(Reg. No. 39,081)
Maria Erlinda C. Sarno	(Reg. No. 37,436)	Charles Liu	(Reg. No. 53,226)
Belinda Lee	(Reg. No. 46,863)		

SEND CORRESPONDENCE TO:

DIRECT TELEPHONE CALLS TO:

(Name and telephone number)

J.C. Patents, Inc.
4 Venture, Suite 250
Irvine, CA 92618
(949) 660-0761

Jiawei Huang
(949) 660-0762

COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

Signature:  Date: Nov. 20, 2003
Sole or First Joint Inventor: Tri-Rung Yew
Citizenship: Taiwan, R.O.C.

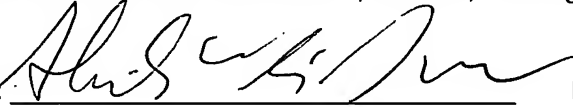
Residence and Post Office Address: 14Fl.-1, No. 25, Jianjung 1st Rd., Hsinchu, Taiwan 300, R.O.C.

Signature:  Date: Nov. 20, 2003
Second Joint Inventor (if any): Yimin Huang
Citizenship: Taiwan, R.O.C.

Residence and Post Office Address: No. 61, Jia-Nan Rd., Qing-Shui Zhen, Taichung Hsien, Taiwan, R.O.C.

Signature:  Date: Nov. 24, 2003
Third Joint Inventor (if any): Water Lur
Citizenship: Taiwan, R.O.C.

Residence and Post Office Address: 3F, No. 513, Fuhsing N. Rd., Taipei, Taiwan, R.O.C.

Signature:  Date: 11/28/03
Fourth Joint Inventor (if any): Shih-Wei Sun
Citizenship: Taiwan, R.O.C.

Residence and Post Office Address: 5F, No. 33, Alley 26, Lane 300, Jen-Ai Rd., Sec. 4, Taipei, Taiwan, R.O.C.